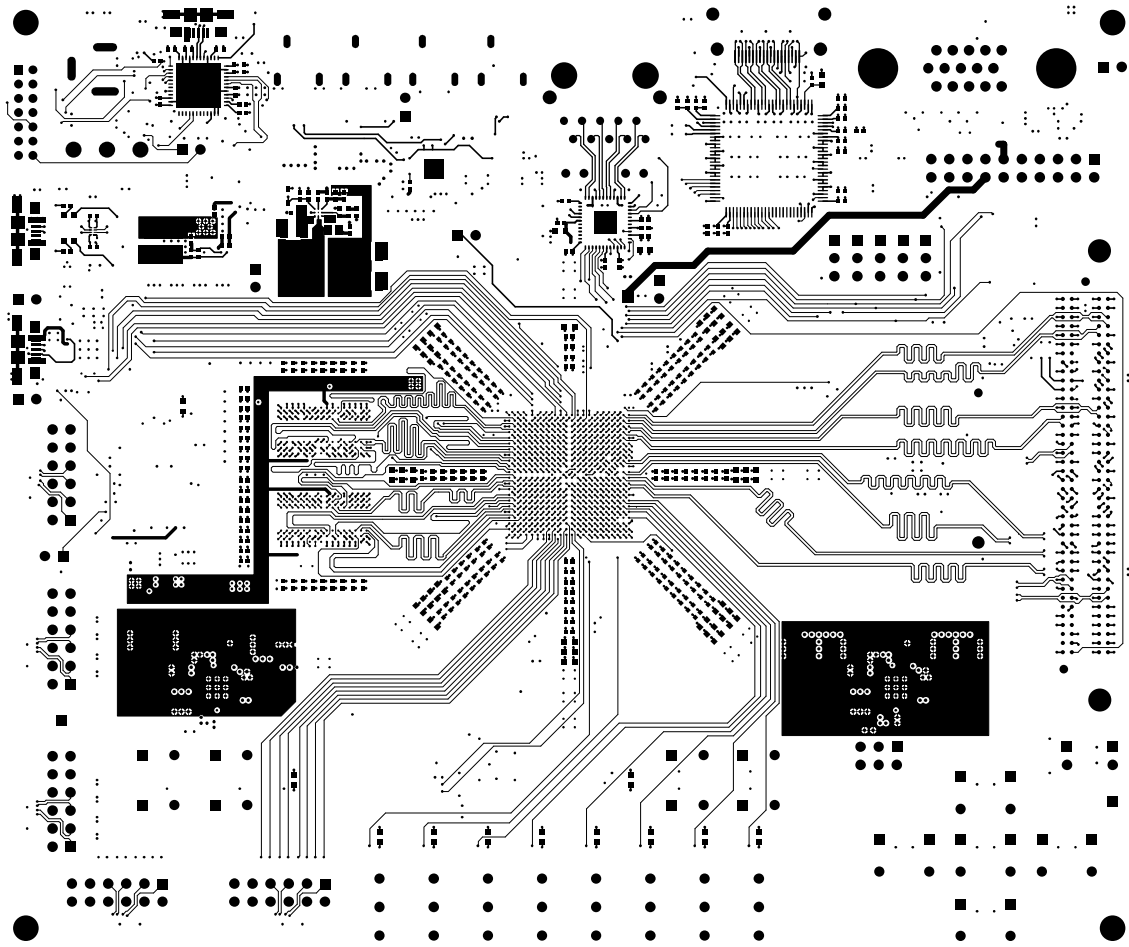
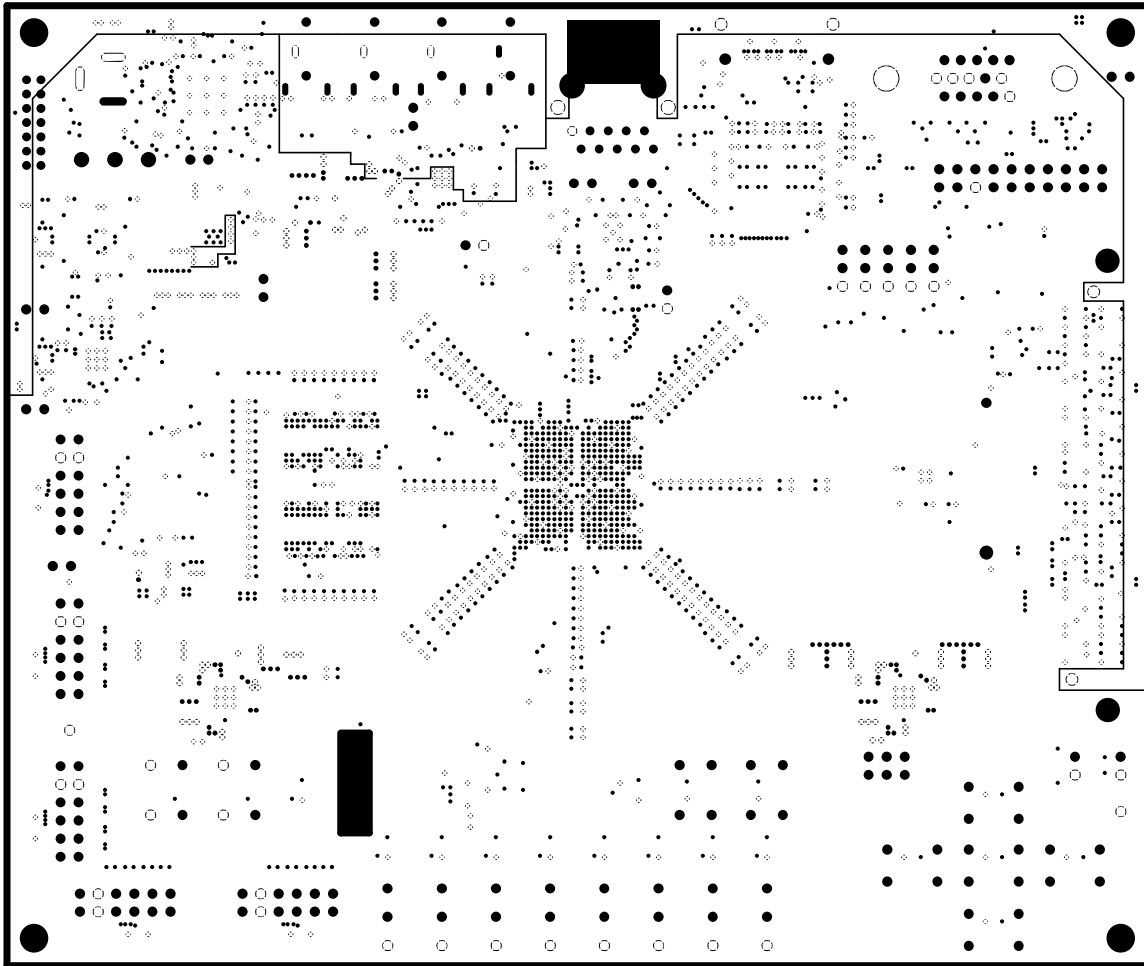
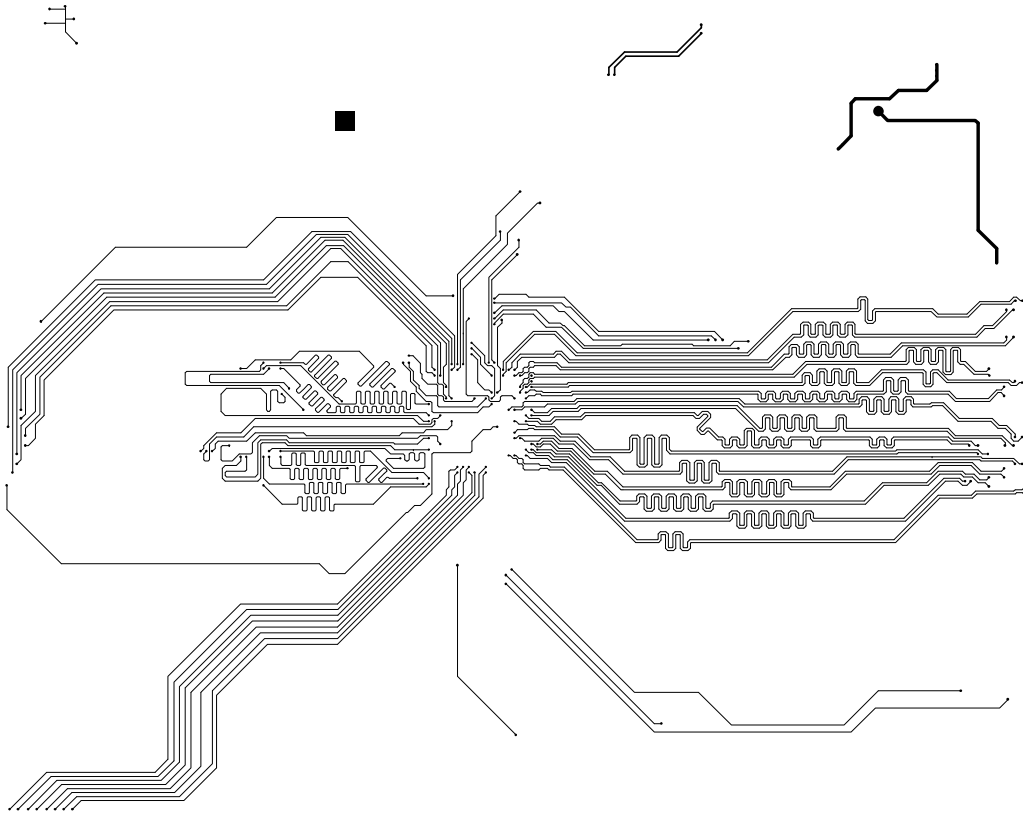


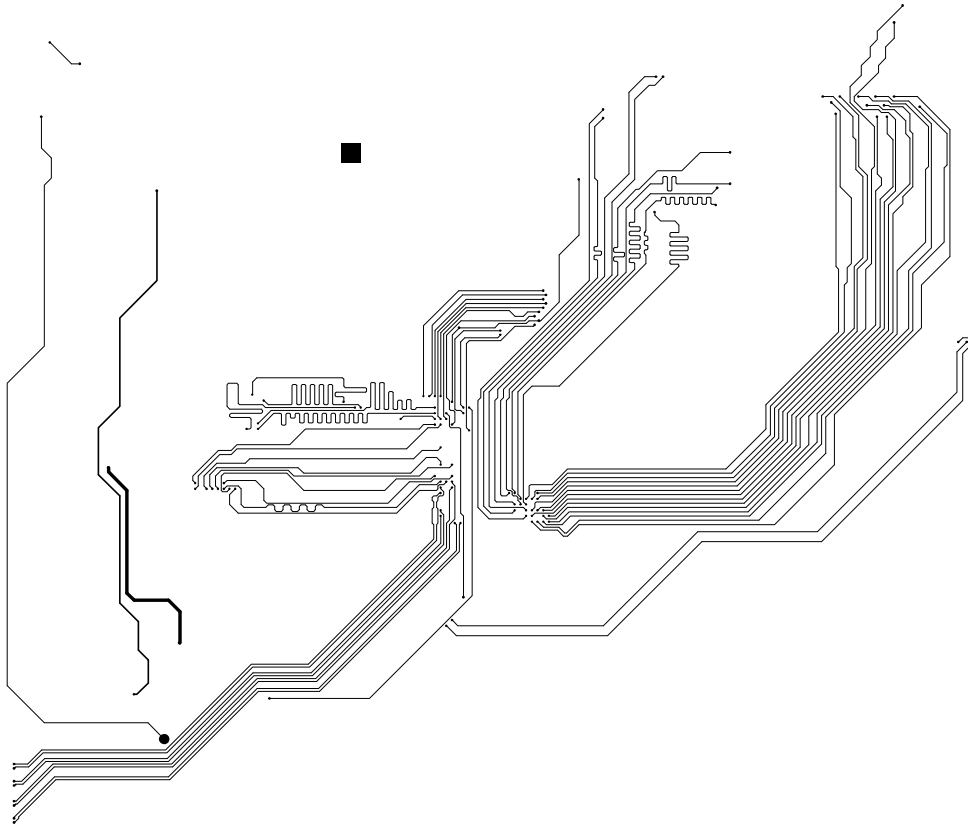
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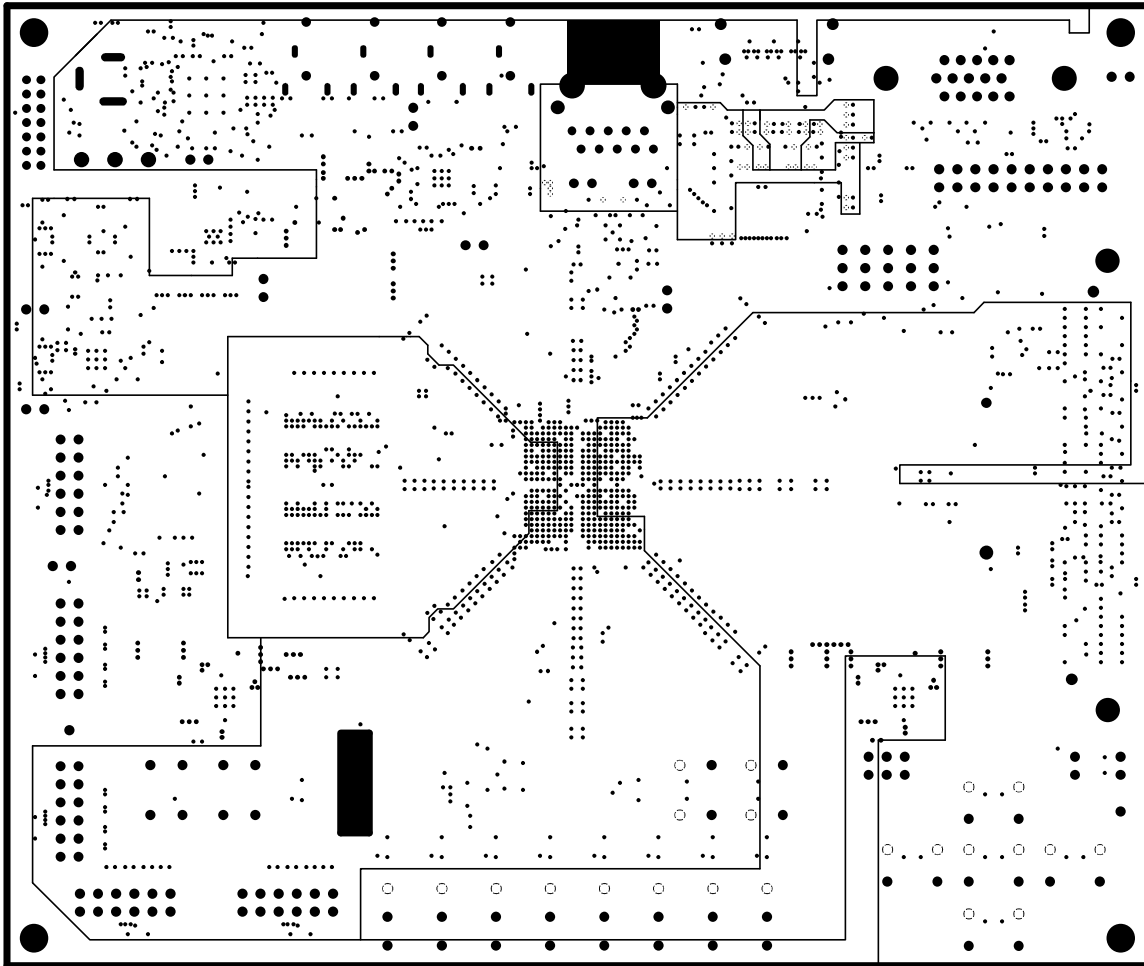
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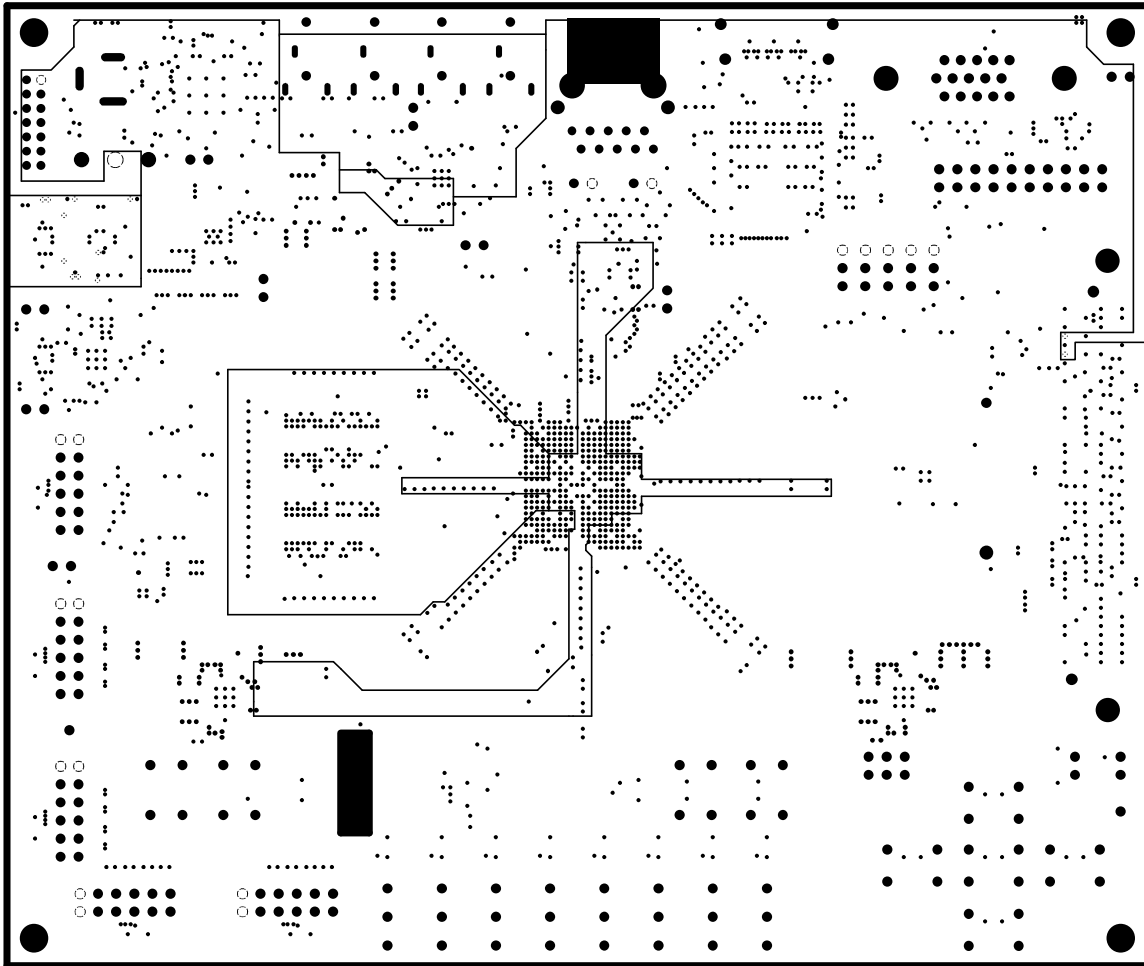


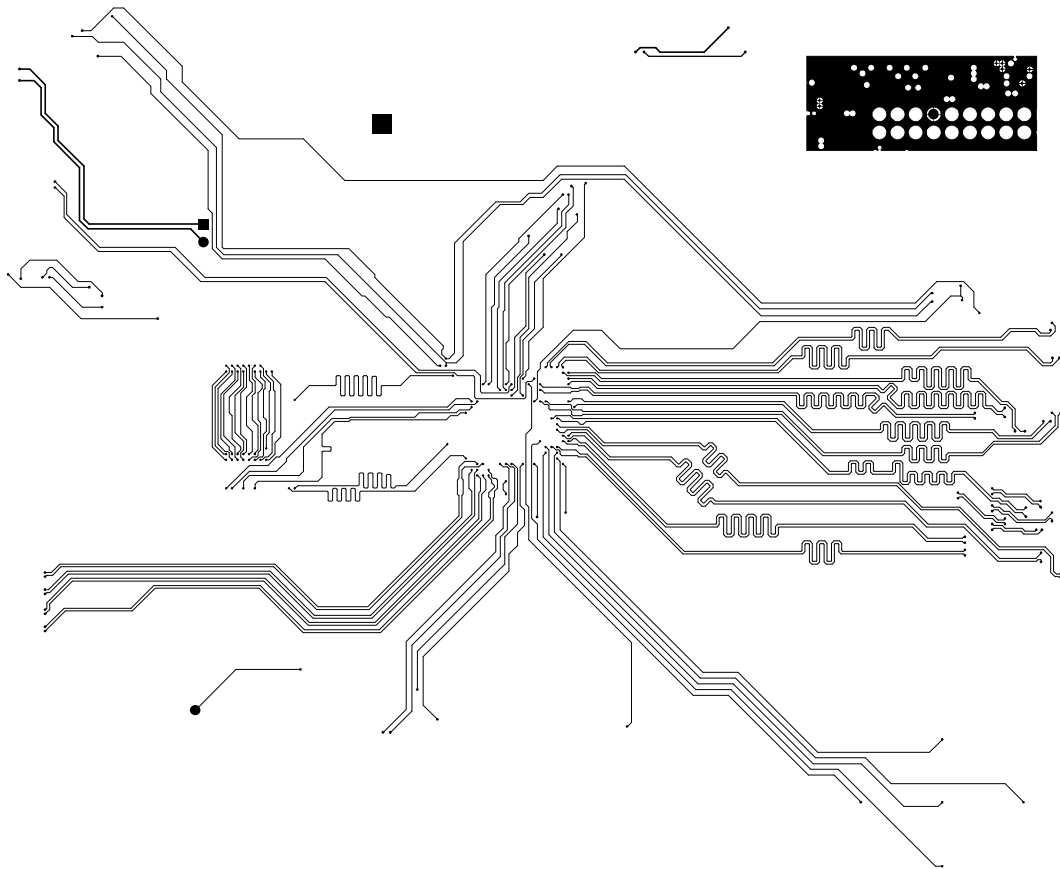


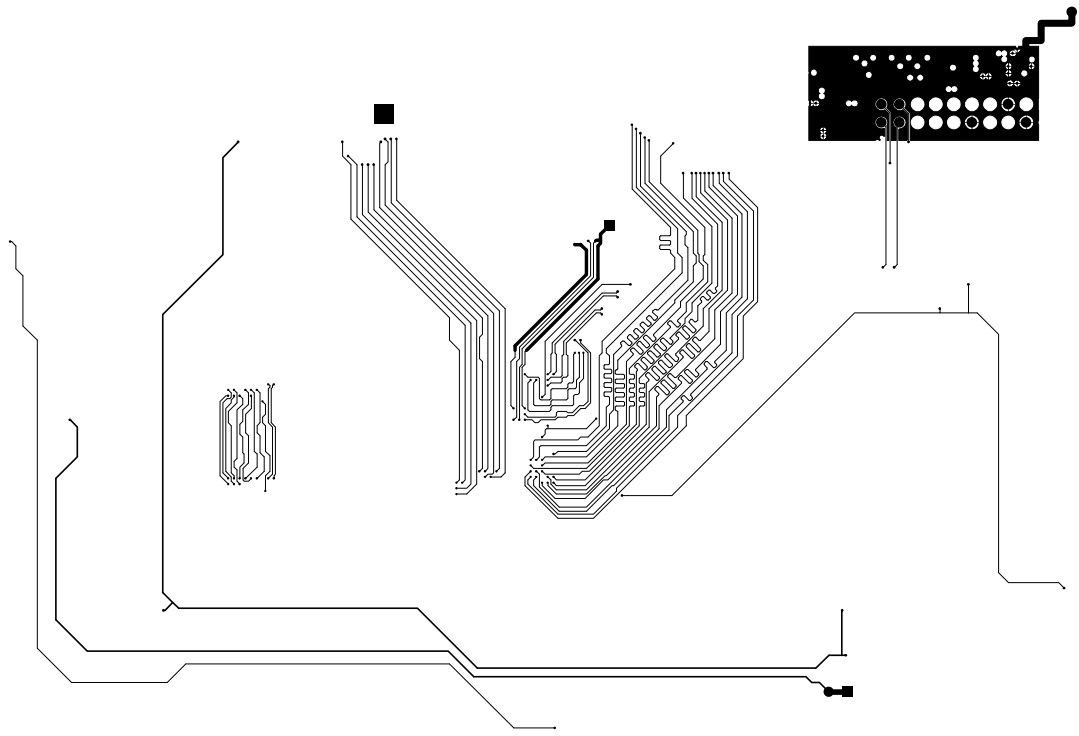


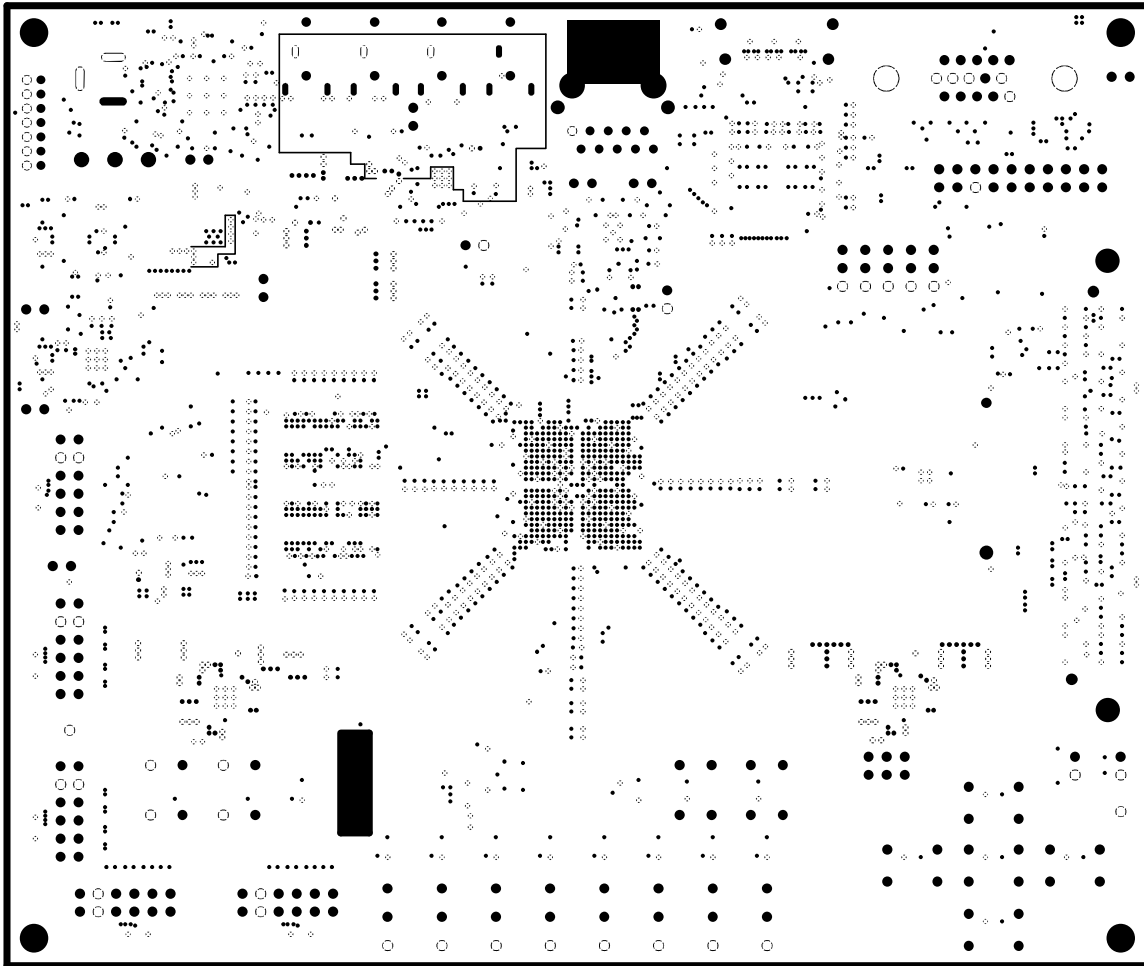


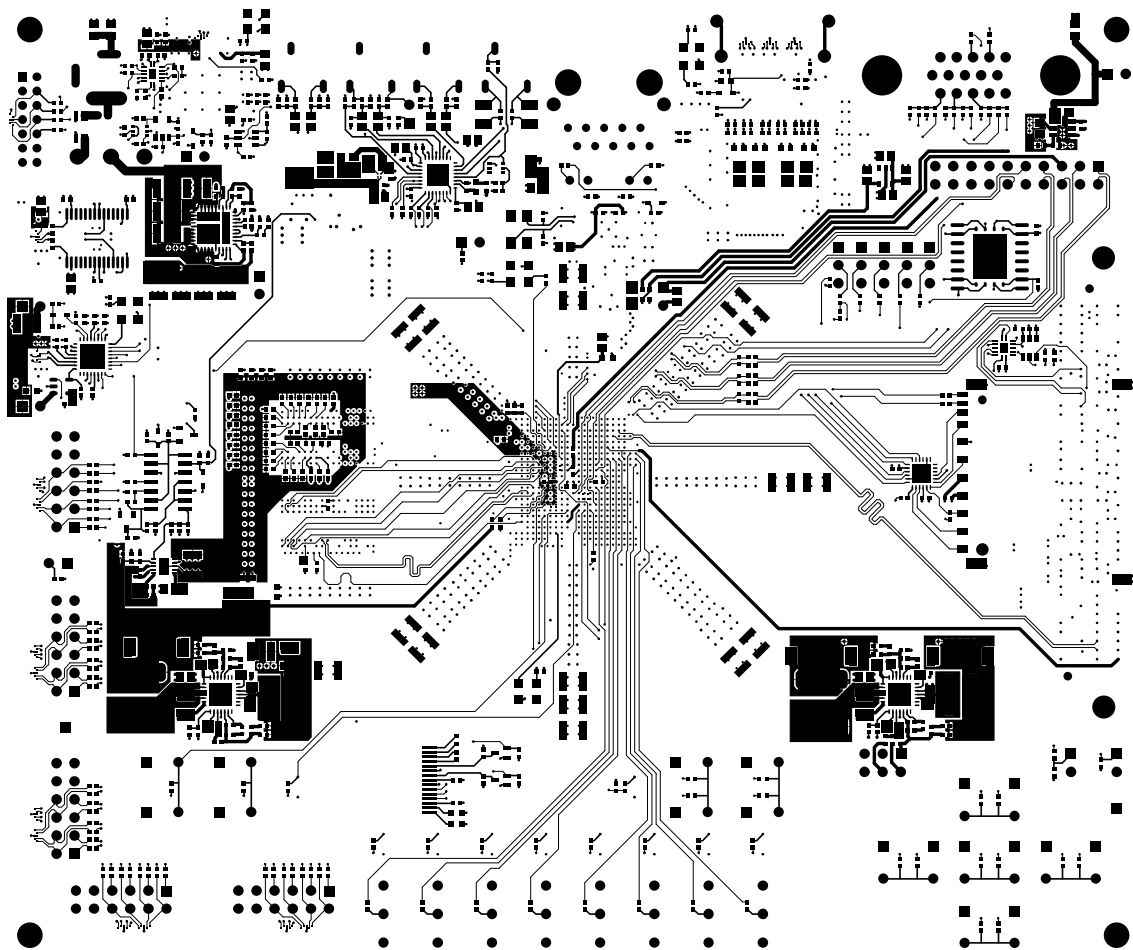


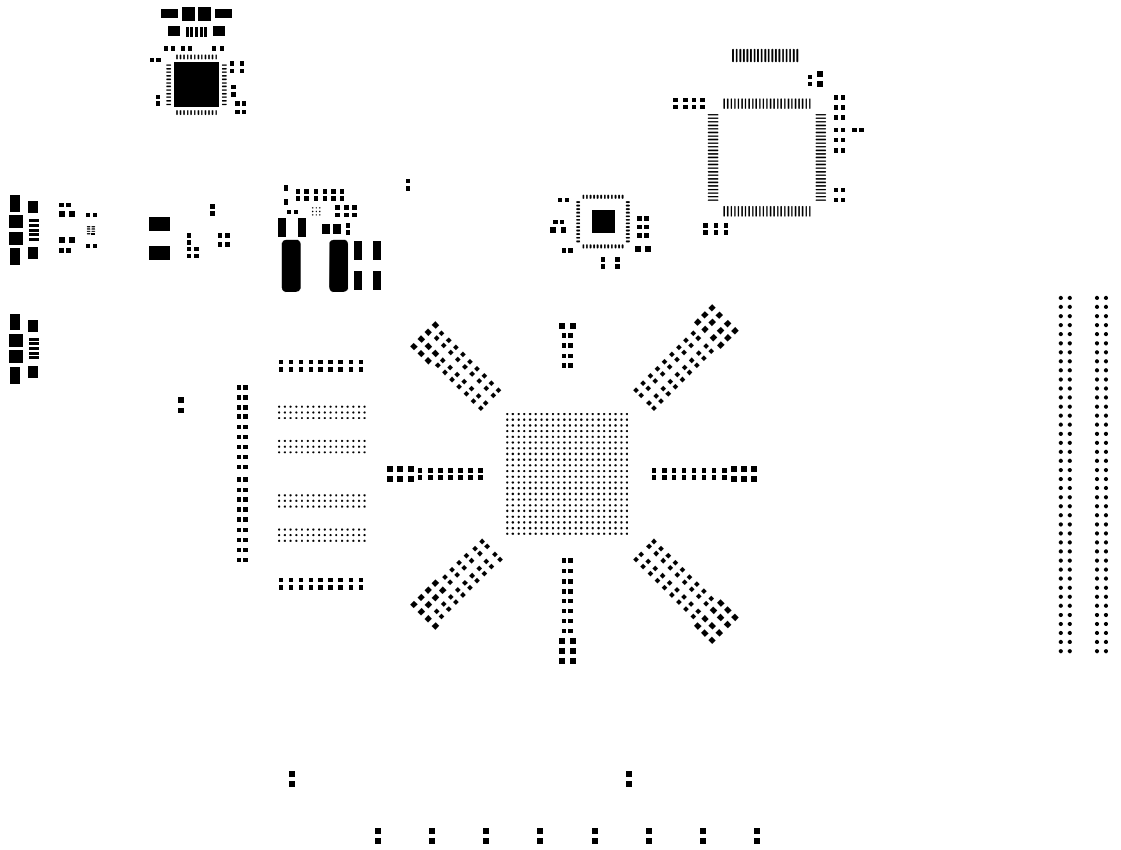


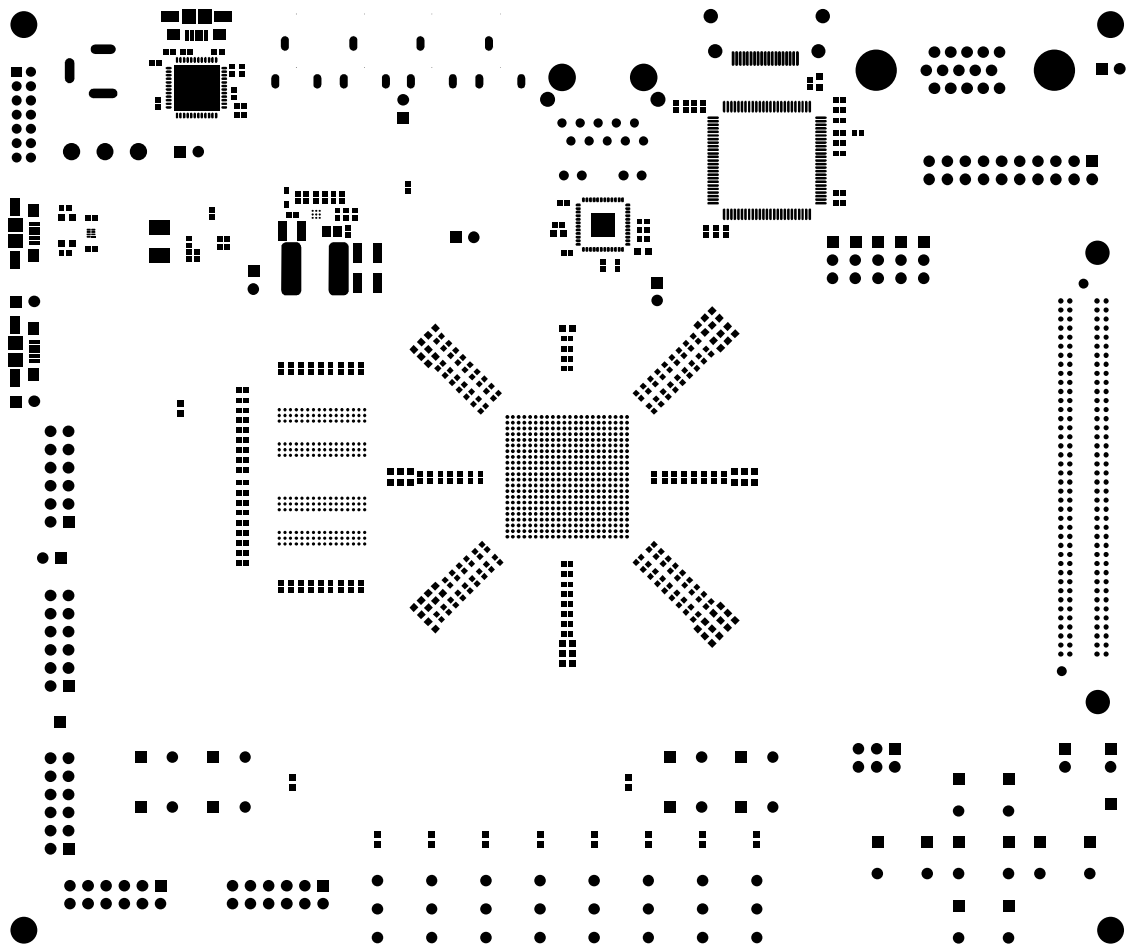


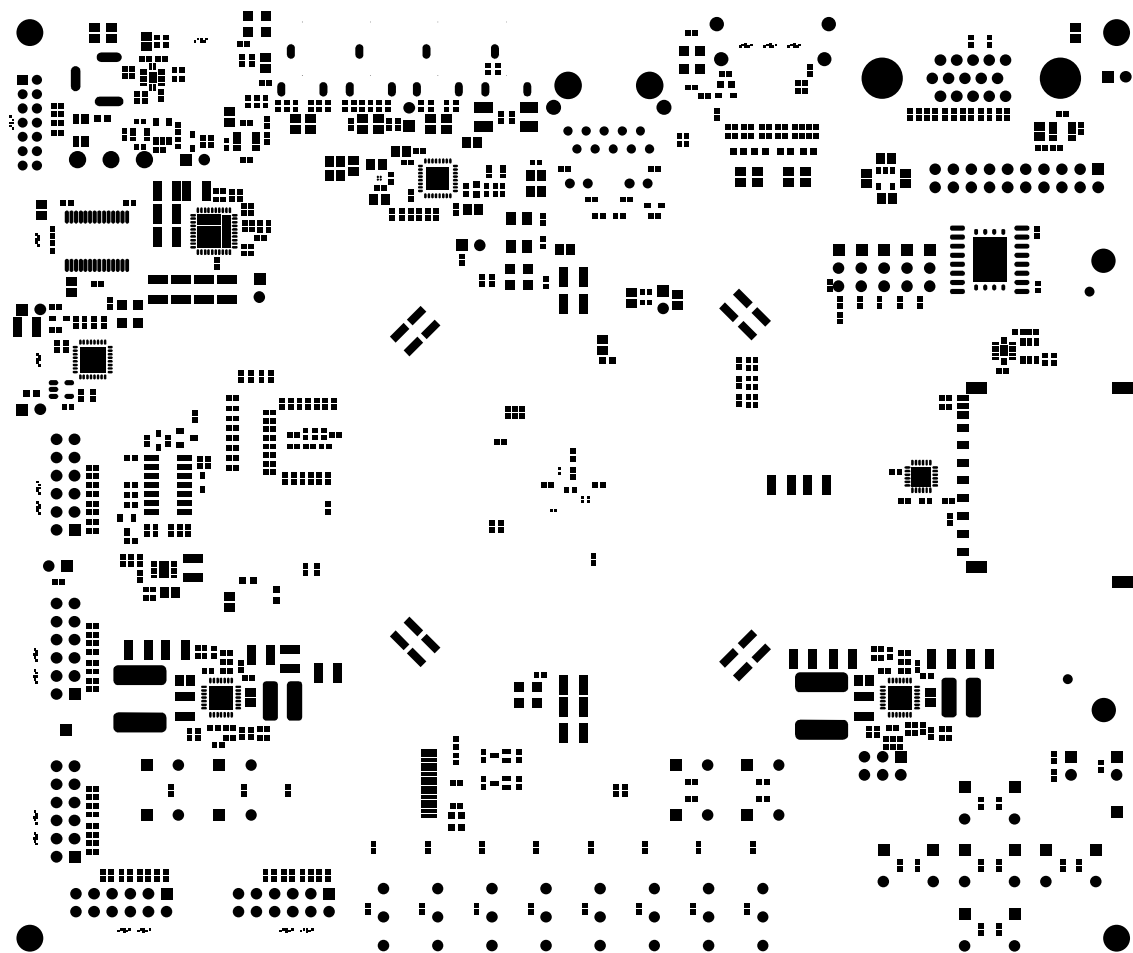


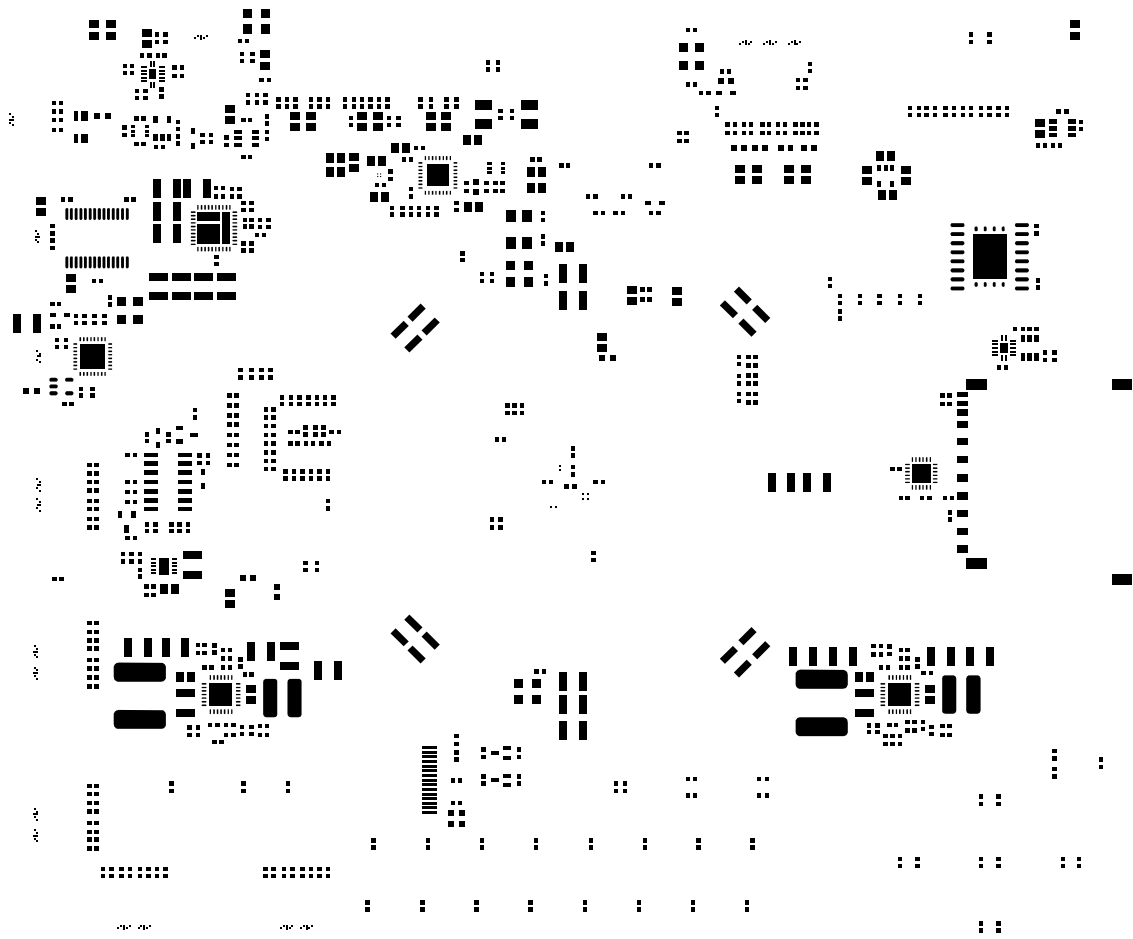


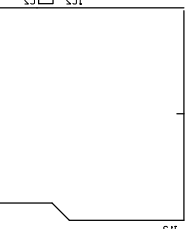
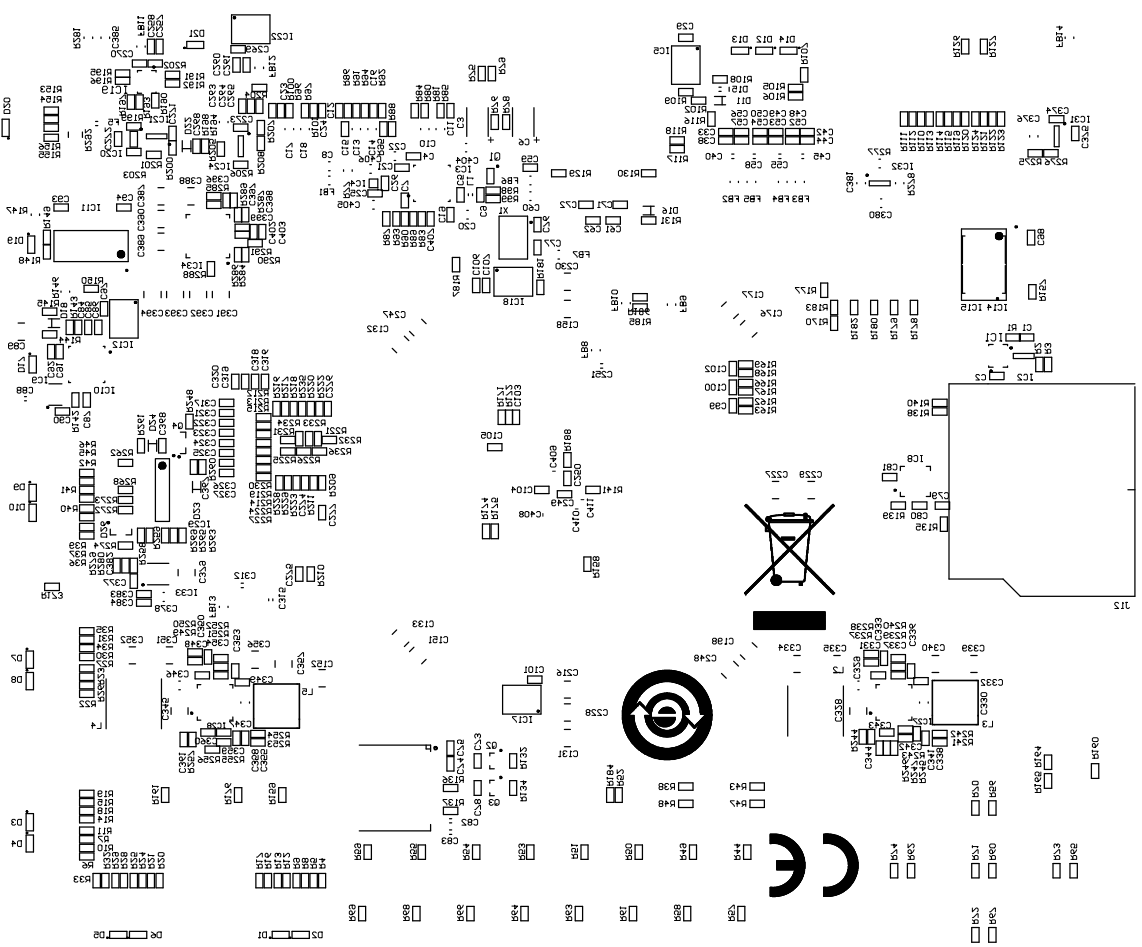




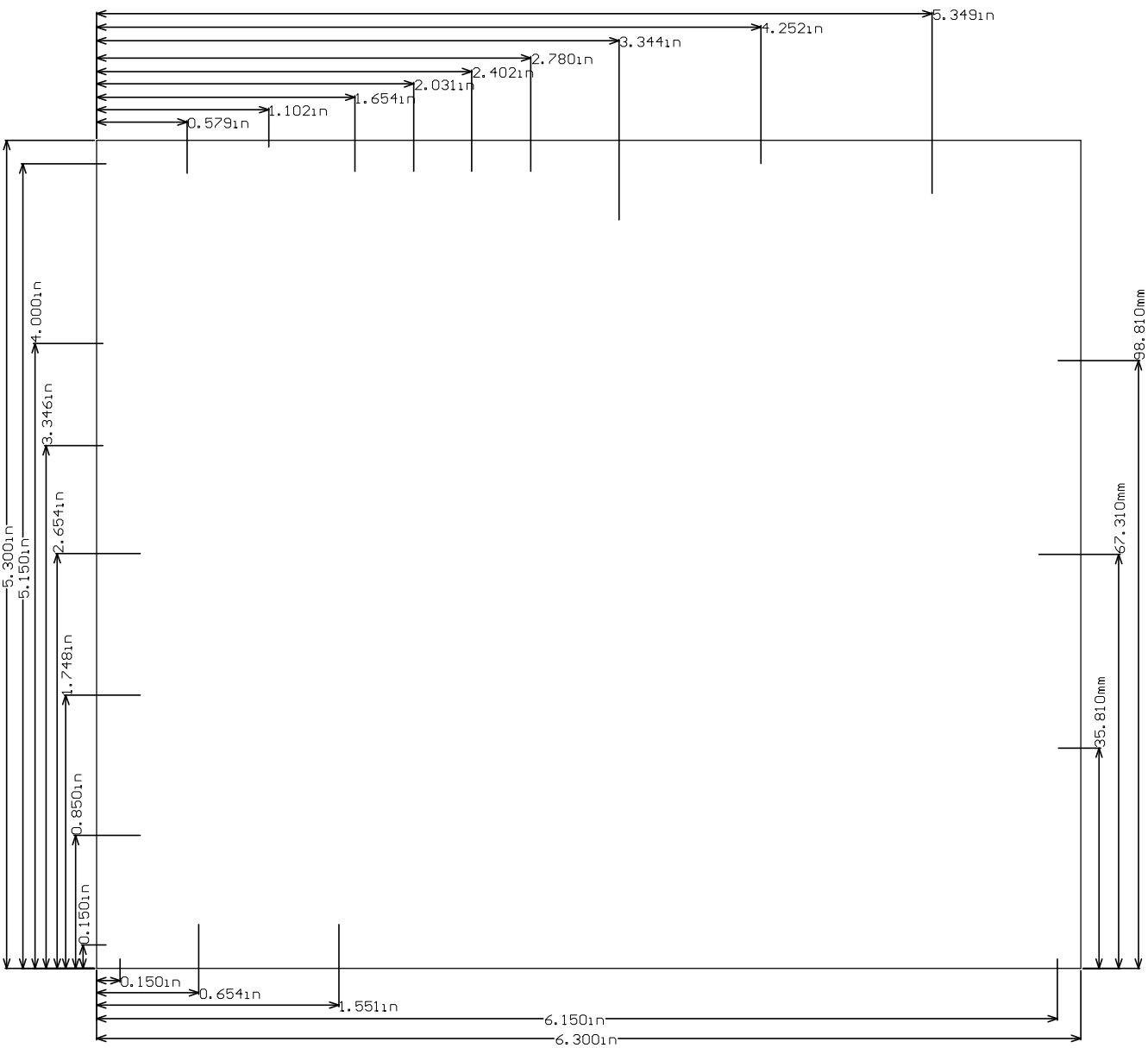








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Layer Stack Up Detail for: ZED.PcbDoc

Layer Name	Gerber Document	Copper Thickness	Dielectric Height	Dielectric Material	Dielectric Constant	Dielectric Type
Top Solder Mask	<.GTS>		0.0102mm	Solder Resist	3.50	
Top Layer	<.GTL>	0.0356mm	0.1mm	FR-4	4.80	Core
GND2	<.GPI>	0.0356mm	0.125mm	FR-4	4.80	PrePreg
Mid-Layer 1	<.G1>	0.017mm	0.125mm	FR-4	4.80	Core
Mid-Layer 2	<.G2>	0.017mm	0.125mm	FR-4	4.80	PrePreg
POWER1	<.GP2>	0.0356mm	0.35mm	FR-4	4.80	Core
POWER2	<.GP3>	0.0356mm	0.125mm	FR-4	4.80	PrePreg
MidLayer3	<.G3>	0.017mm	0.125mm	FR-4	4.80	Core
Mid-Layer 4	<.G4>	0.017mm	0.125mm	FR-4	4.80	PrePreg
GND7	<.GP4>	0.0356mm	0.1mm	FR-4	4.80	Core
Bottom Layer	<.GBL>	0.0356mm				
Bottom Solder Mask	<.GBS>		0.0102mm	Solder Resist	3.50	

